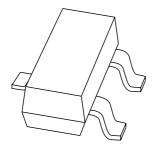
DISCRETE SEMICONDUCTORS

DATA SHEET



BC849; BC850 NPN general purpose transistors

Product data sheet Supersedes data of 1999 Apr 08 2004 Jan 16



NPN general purpose transistors

BC849; BC850

FEATURES

• Low current (max. 100 mA)

• Low voltage (max. 45 V).

APPLICATIONS

• General purpose switching and amplification.

DESCRIPTION

NPN transistor in a SOT23 plastic package. PNP complements: BC859 and BC860.

MARKING

| TYPE NUMBER | MARKING CODE ⁽¹⁾ | TYPE NUMBER | MARKING CODE ⁽¹⁾ | |
|----------------|--------------------------------|----------------|--------------------------------|--|
| BC849B | 2B* | BC850B | 2F* | |
| BC849C | 2C* | BC850C | 2G* | |

Note

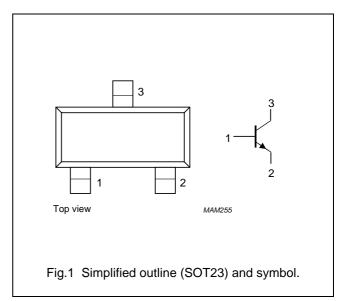
1. * = p: Made in Hong Kong.

* = t : Made in Malaysia.

* = W : Made in China.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |



ORDERING INFORMATION

| TYPE | | | |
|--------|------------------|--|---------|
| NUMBER | NAME DESCRIPTION | | VERSION |
| BC849B | _ | plastic surface mounted package; 3 leads | SOT23 |
| BC849C |] | | |
| BC850B | | | |
| BC850C | 1 | | |

NPN general purpose transistors

BC849; BC850

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|----------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | | | |
| | BC849 | | _ | 30 | V |
| | BC850 | | _ | 50 | V |
| V _{CEO} | collector-emitter voltage | open base | | | |
| | BC849 | | _ | 30 | V |
| | BC850 | | _ | 45 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | 5 | V |
| I _C | collector current (DC) | | _ | 100 | mA |
| I _{CM} | peak collector current | | - | 200 | mA |
| I _{BM} | peak base current | | _ | 200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Note

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | note 1 | 500 | K/W |

Note

1. Transistor mounted on an FR4 printed-circuit board.

^{1.} Transistor mounted on an FR4 printed-circuit board.

NPN general purpose transistors

BC849; BC850

CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|---------------------------------|--|------|------|------|------|
| I _{CBO} | collector cut-off current | I _E = 0; V _{CB} = 30 V | _ | _ | 15 | nA |
| | | I _E = 0; V _{CB} = 30 V; T _j = 150 °C | _ | _ | 5 | μΑ |
| I _{EBO} | emitter cut-off current | I _C = 0; V _{EB} = 5 V | _ | _ | 100 | nA |
| h _{FE} | DC current gain | $I_C = 10 \mu A; V_{CE} = 5 V;$ | | | | |
| | BC849B; BC850B | see Figs 2 and 3 | _ | 240 | _ | |
| | BC849C; BC850C | | _ | 450 | _ | |
| | DC current gain | $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V};$ | | | | |
| | BC849B; BC850B | see Figs 2 and 3 | 200 | 290 | 450 | |
| | BC849C; BC850C | | 420 | 520 | 800 | |
| V _{CEsat} | collector-emitter saturation | $I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$ | _ | 90 | 250 | mV |
| | voltage | $I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$ | _ | 200 | 600 | mV |
| V_{BEsat} | base-emitter saturation voltage | $I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}; \text{ note 1}$ | _ | 700 | _ | mV |
| | | $I_C = 100 \text{ mA}$; $I_B = 5 \text{ mA}$; note 1 | _ | 900 | _ | mV |
| V_{BE} | base-emitter voltage | $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}; \text{ note } 2$ | 580 | 660 | 700 | mV |
| | | $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}; \text{ note 2}$ | _ | _ | 770 | mV |
| C _c | collector capacitance | $I_E = i_e = 0$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$ | _ | 2.5 | _ | pF |
| C _e | emitter capacitance | $I_C = i_c = 0$; $V_{EB} = 500 \text{ mV}$; $f = 1 \text{ MHz}$ | _ | 11 | _ | pF |
| f _T | transition frequency | $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}; f = 100 \text{ MHz}$ | 100 | _ | _ | MHz |
| F | noise figure | $\begin{split} I_{C} &= 200 \; \mu\text{A}; \; V_{CE} = 5 \; V; \; R_{S} = 2 \; k\Omega; \\ f &= 10 \; \text{Hz} \; \text{to} \; 15.7 \; \text{kHz} \end{split}$ | - | _ | 4 | dB |
| | | I_C = 200 μA; V_{CE} = 5 V; R_S = 2 kΩ; f = 1 kHz; B = 200 Hz | _ | _ | 4 | dB |

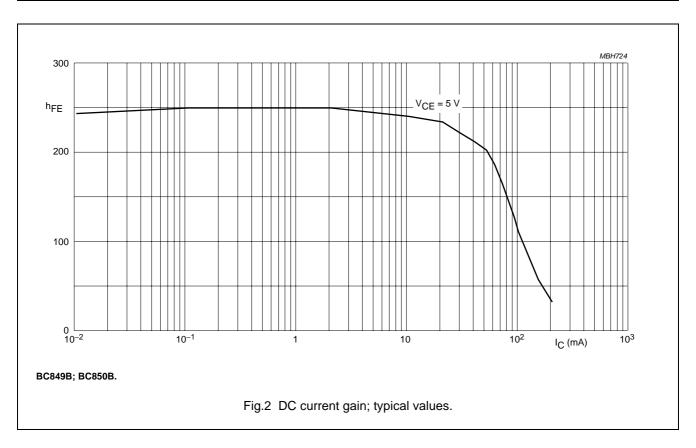
Notes

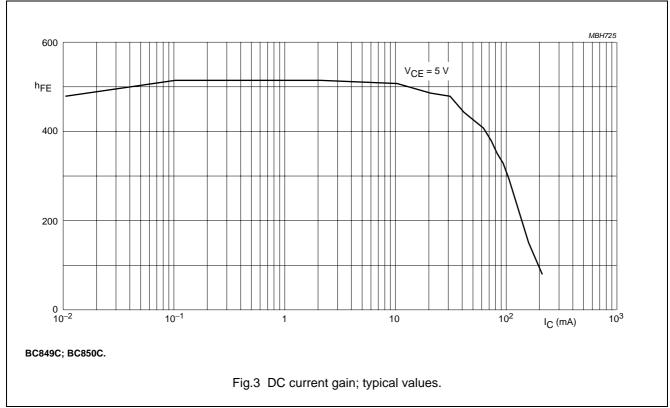
- 1. V_{BEsat} decreases by about 1.7 mV/K with increasing temperature.
- 2. V_{BE} decreases by about 2 mV/K with increasing temperature.

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BC849; BC850





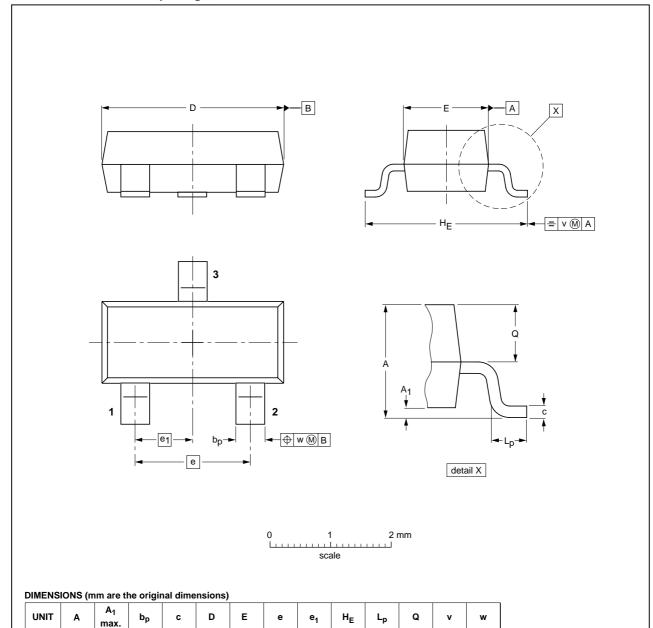
NPN general purpose transistors

BC849; BC850

PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT23



| OUTLINE | REFERENCES | | | EUROPEAN | ICCUE DATE | |
|---------|------------|----------|-------|----------|------------|-----------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT23 | | TO-236AB | | | | -04-11-04- 06-03-16 |

0.45

0.55

0.1

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max

0.38

0.9

NPN general purpose transistors

BC849; BC850

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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Customer notification

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Contact information

For additional information please visit: http://www.nxp.com
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